

H5N2504DL, H5N2504DS

Silicon N Channel MOS FET
High Speed Power Switching

REJ03G1106-0200
(Previous: ADE-208-1375A)
Rev.2.00
Sep 07, 2005

Features

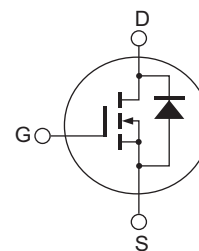
- Low on-resistance
- Low leakage current
- High speed switching
- Low gate charge
- Avalanche ratings

Outline

RENESAS Package code: PRSS0004ZD-B
(Package name: DPAK (L)-(2))



RENESAS Package code: PRSS0004ZD-C
(Package name: DPAK (S))



1. Gate
2. Drain
3. Source
4. Drain

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	250	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	7	A
Drain peak current	I _{D (pulse)} ^{Note 1}	28	A
Body-drain diode reverse drain current	I _{DR}	7	A
Body-drain diode reverse drain peak current	I _{DR (pulse)} ^{Note 1}	28	A
Avalanche current	I _{AP} ^{Note 3}	7	A
Channel dissipation	P _{ch} ^{Note 2}	30	W
Channel to case thermal impedance	θ _{ch-c}	4.17	°C/W
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

- Notes: 1. PW ≤ 10 μs, duty cycle ≤ 1%
 2. Value at Tc = 25°C
 3. T_{ch} ≤ 150°C

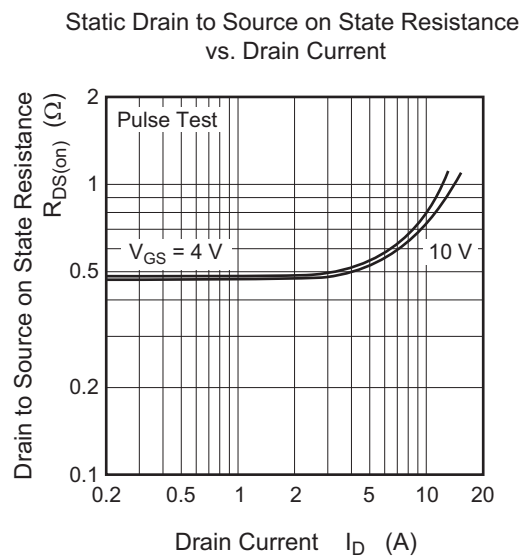
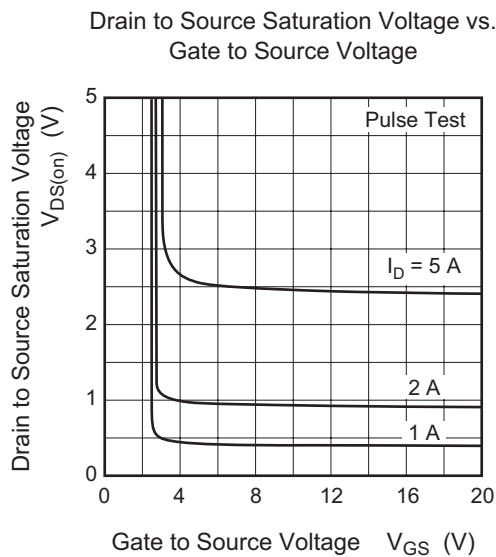
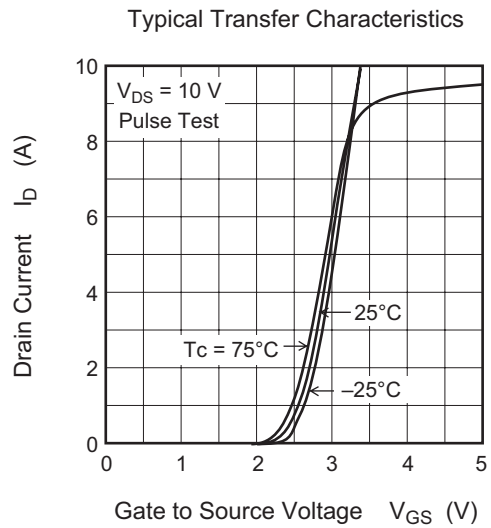
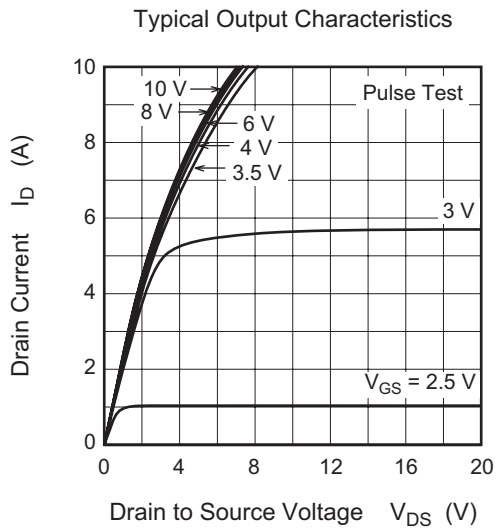
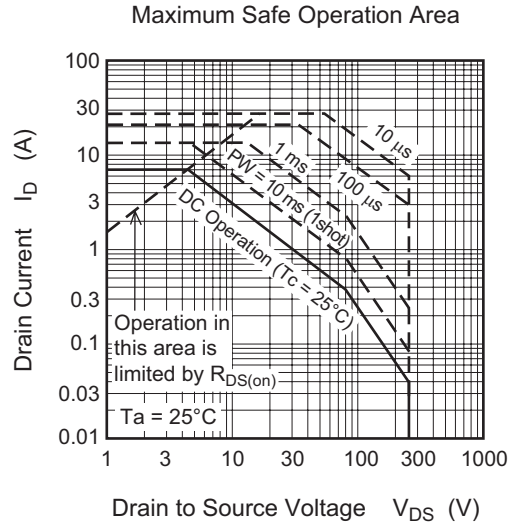
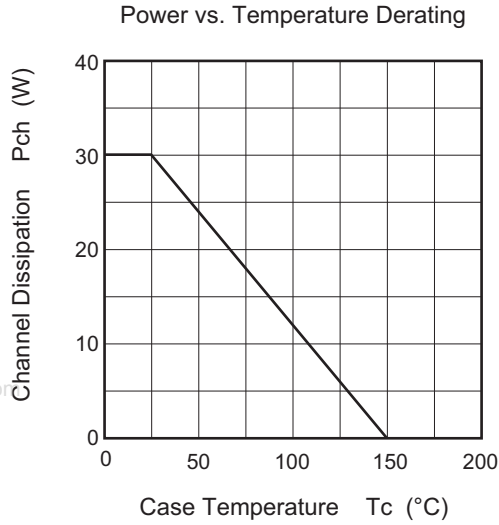
Electrical Characteristics

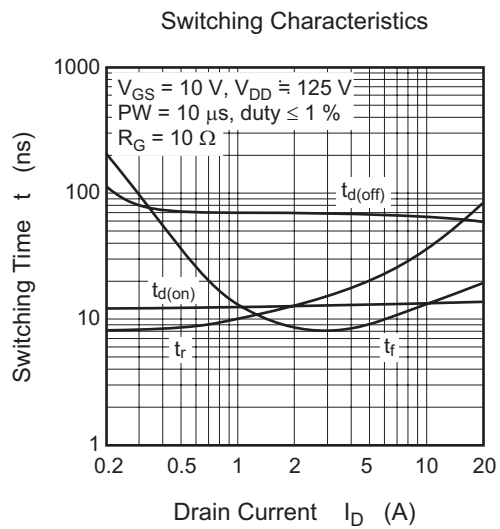
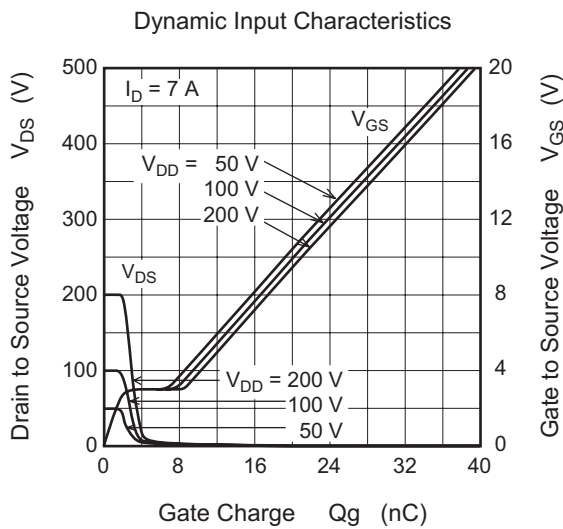
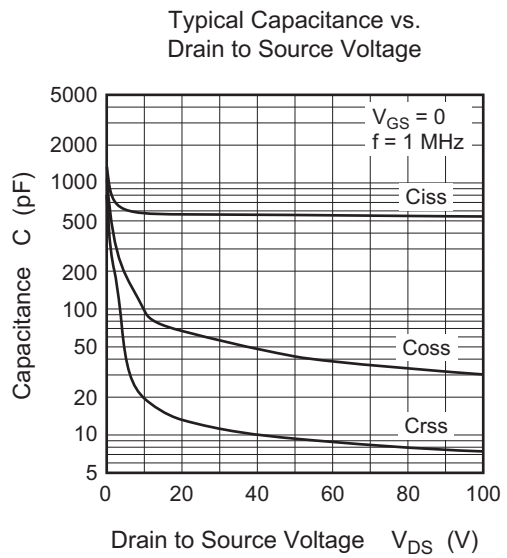
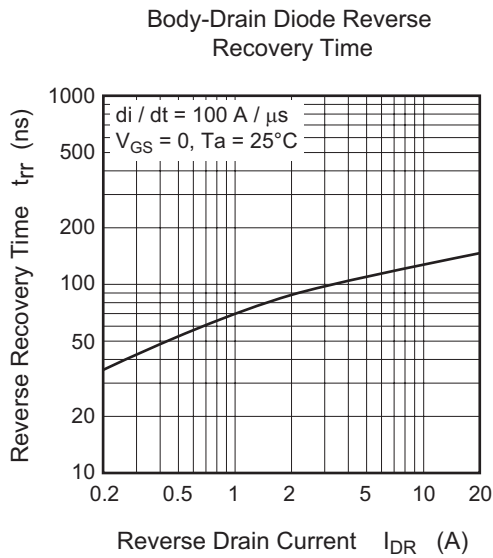
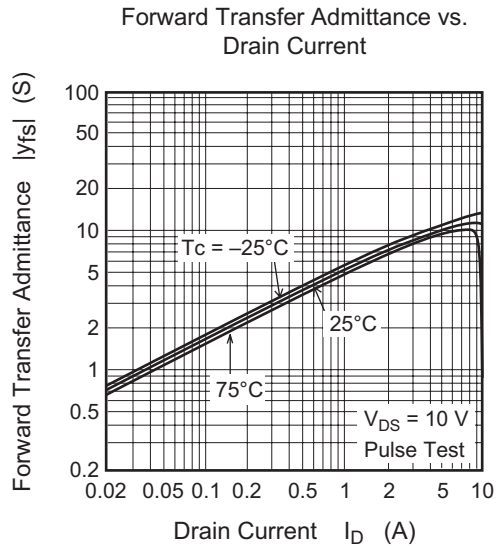
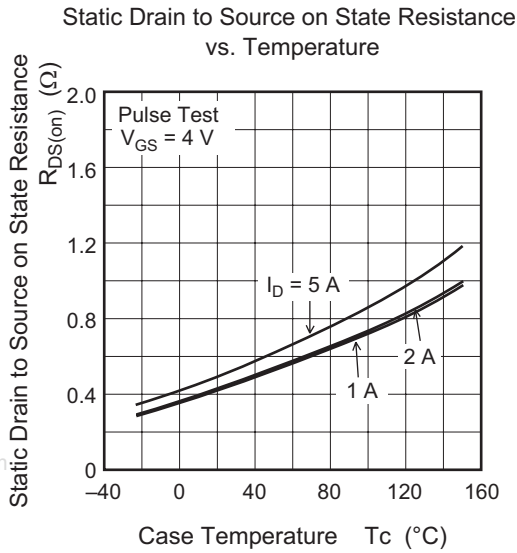
(Ta = 25°C)

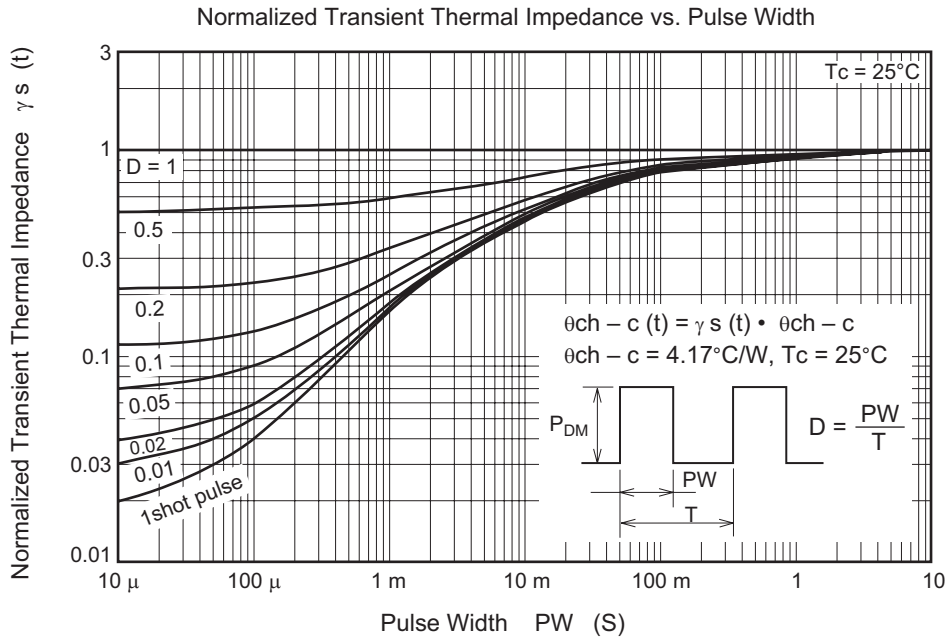
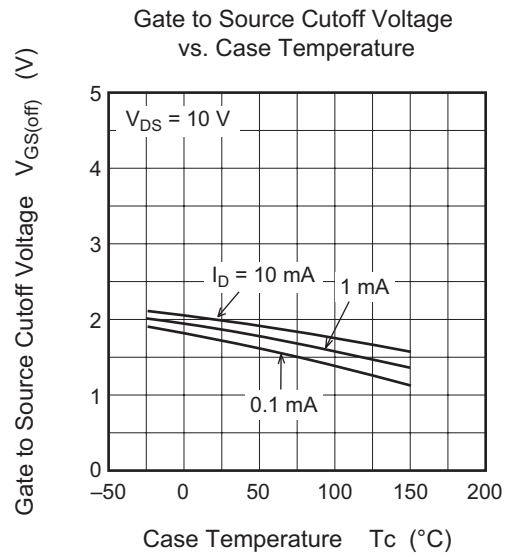
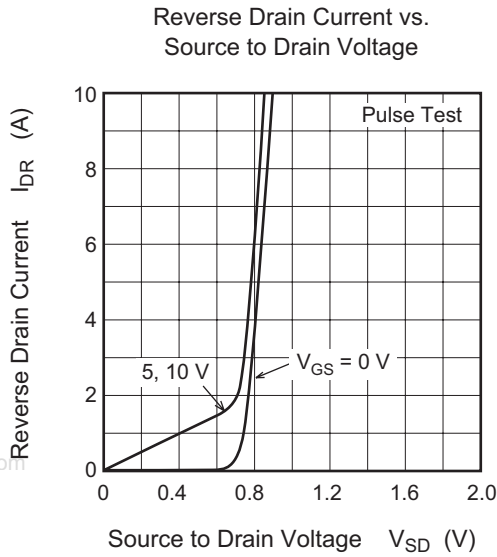
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR) DSS}	250	—	—	V	I _D = 10 mA, V _{GS} = 0
Gate to source leak current	I _{GSS}	—	—	±0.1	μA	V _{GS} = ±20 V, V _{DS} = 0
Zero gate voltage drain current	I _{DSS}	—	—	1	μA	V _{DS} = 250 V, V _{GS} = 0
Gate to source cutoff voltage	V _{GS (off)}	1.0	—	2.5	V	V _{DS} = 10 V, I _D = 1 mA
Static drain to source on state resistance	R _{DS (on)}	—	0.48	0.63	Ω	I _D = 3.5 A, V _{GS} = 10 V ^{Note 4}
	R _{DS (on)}	—	0.5	0.67	Ω	I _D = 3.5 A, V _{GS} = 4 V ^{Note 4}
Forward transfer admittance	y _{fs}	5	8.5	—	S	I _D = 3.5 A, V _{DS} = 10 V ^{Note 4}
Input capacitance	C _{iss}	—	570	—	pF	V _{DS} = 25 V
Output capacitance	C _{oss}	—	60	—	pF	V _{GS} = 0
Reverse transfer capacitance	C _{rss}	—	12	—	pF	f = 1 MHz
Turn-on delay time	t _{d (on)}	—	13	—	ns	I _D = 3.5 A
Rise time	t _r	—	18	—	ns	V _{GS} = 10 V
Turn-off delay time	t _{d (off)}	—	70	—	ns	R _L = 35.7 Ω
Fall time	t _f	—	8	—	ns	R _g = 10 Ω
Total gate charge	Q _g	—	21	—	nC	V _{DD} = 200 V
Gate to source charge	Q _{gs}	—	2	—	nC	V _{GS} = 10 V
Gate to drain charge	Q _{gd}	—	6	—	nC	I _D = 7 A
Body-drain diode forward voltage	V _{DF}	—	0.85	1.30	V	I _F = 7 A, V _{GS} = 0
Body-drain diode reverse recovery time	t _{rr}	—	120	—	ns	I _F = 7 A, V _{GS} = 0
Body-drain diode reverse recovery charge	Q _{rr}	—	0.48	—	μC	di _F /dt = 100 A/μs

- Note: 4. Pulse test

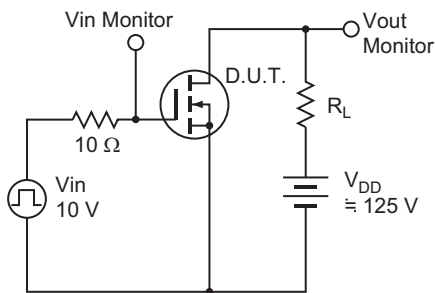
Main Characteristics



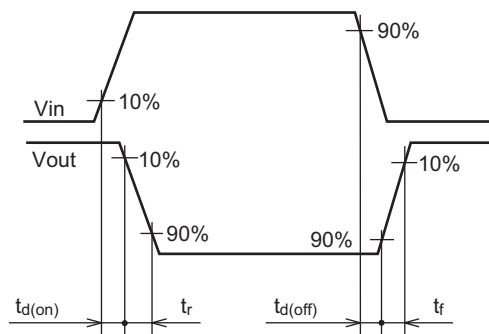




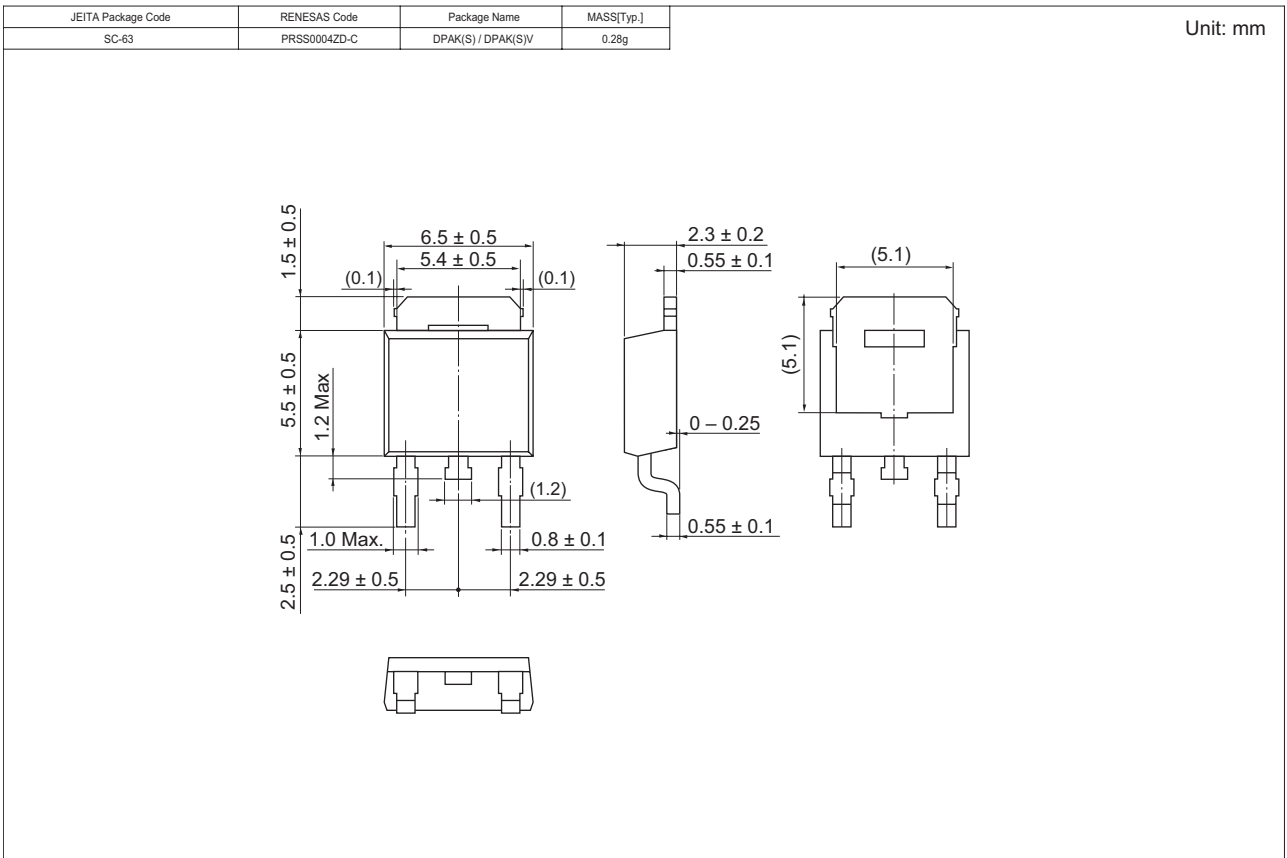
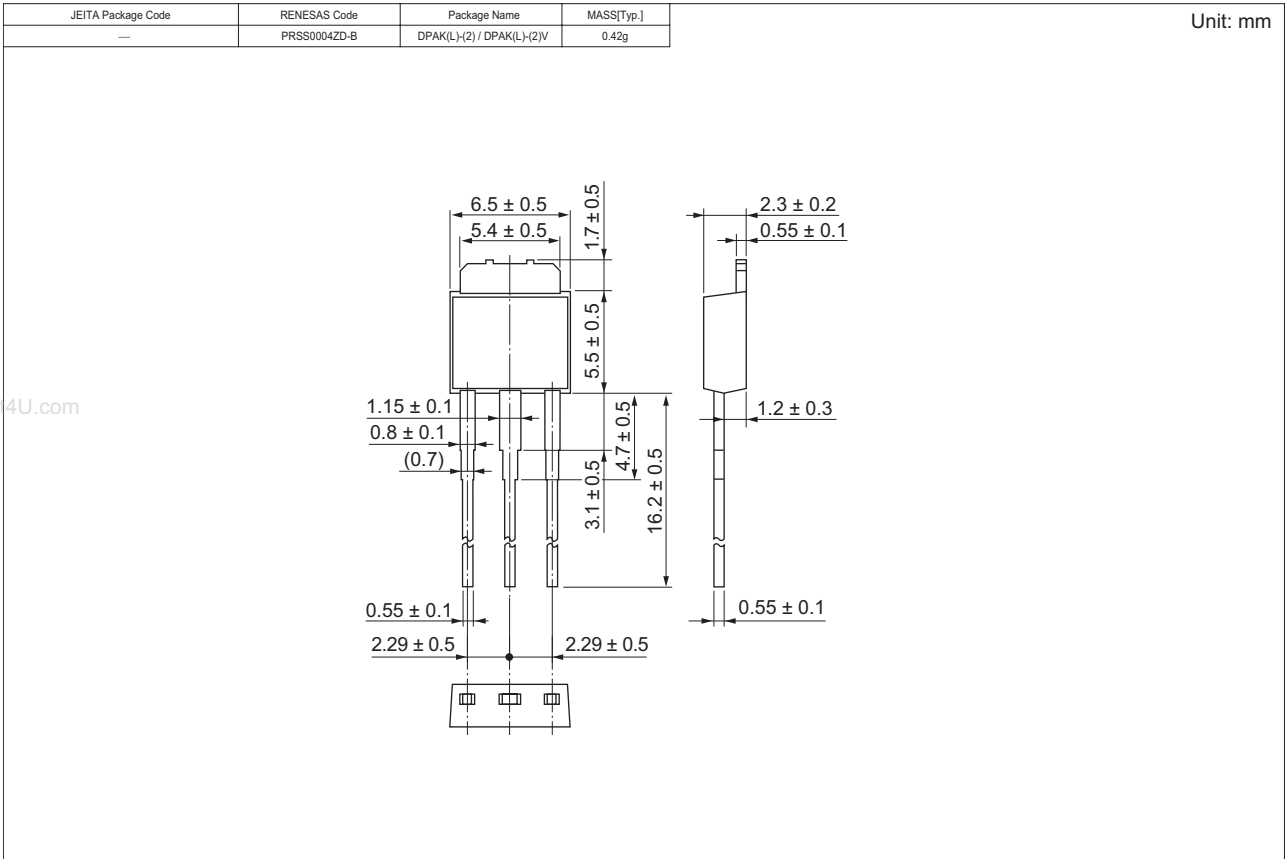
Switching Time Test Circuit



Waveform



Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
H5N2504DL-E	3200 pcs	Box (Sack)
H5N2504DSTL-E	3000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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